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Vishay Semiconductors

Ultrafast Rectifier, 16 A FRED Pt®



PRIMARY CHARACTERISTICS								
I _{F(AV)} 2 x 8 A								
V_{R}	400 V							
V _F at I _F	0.94 V							
t _{rr} typ.	See Recovery table							
T _J max.	175 °C							
Package	TO-220AB 3L							
Circuit configuration	Common cathode							

FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



DESCRIPTION / APPLICATIONS

FRED Pt® series are the state of the art ultrafast recovery rectifiers specifically designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Peak repetitive reverse voltage		V _{RRM}		400	V					
Average restified forward surrent	per leg			8						
Average rectified forward current	total device	I _{F(AV)}	T _C = 155 °C, rated V _R	16	Α					
Non-repetitive peak surge current		I _{FSM}	T _C = 25 °C	100	_ ^					
Peak repetitive forward current		I _{FRM}	T _C = 155 °C, rated V _R , square wave, 20 kHz	16						
Operating junction and storage temp	peratures	T _J , T _{Stg}		-65 to +175	°C					

ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL TEST CONDITIONS				MAX.	UNITS				
Breakdown voltage, blocking voltage	V_{BR} , V_{R}	I _R = 100 μA	400	-	-	.,				
Famous de la contraction de la	V _F	I _F = 8 A	-	1.19	1.3	V				
Forward voltage		I _F = 8 A, T _J = 150 °C	-	0.94	1.0					
Reverse leakage current	la alca da a cumant	$V_R = V_R$ rated	-	0.2	10					
neverse leakage current	I _R	$T_J = 150 ^{\circ}\text{C}, V_R = V_R \text{rated}$	-	20	500	– μA				
Junction capacitance	C _T	$V_{R} = 400 \text{ V}$	-	14	-	pF				
Series inductance L _S		Measured lead to lead 5 mm from package body	ı	8.0	-	nΗ				



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DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS				
Reverse recovery time	t _{rr}	$I_F = 1.0 A, dI_F/dt =$	$I_F = 1.0 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{A}, V_R = 30 \text{ V}$			60				
		T _J = 25 °C		-	43	-	ns - A			
		T _J = 125 °C	I _F = 8 A dI _F /dt = 200 A/μs V _R = 200 V	=	67	-				
Peak recovery current	I _{RRM}	T _J = 25 °C		-	2.8	-				
		T _J = 125 °C		-	6.3	-				
Reverse recovery charge	Q _{rr}	T _J = 25 °C		=	60	-	nC			
		T _J = 125 °C		-	210	-				

THERMAL MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range		T _J , T _{Stg}		-65	-	175	°C		
Thermal resistance,	per leg	D		-	3.6	4			
junction to case	per device	R_{thJC}		-	1.8	2			
Thermal resistance, junction to ambient		R _{thJA}	Typical socket mount	-	-	50	°C/W		
Thermal resistance, case to heatsink		R _{thCS}	Mounting surface, flat, smooth and greased	-	0.5	-			
Weight				-	2.0	-	g		
				-	0.07	-	OZ.		
Mounting torque				6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Marking device			Case style TO-220AB 3L	16CTU04					

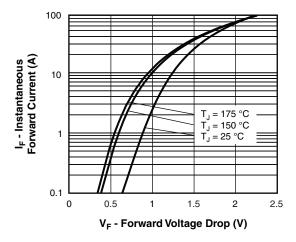


Fig. 1 - Typical Forward Voltage Drop Characteristics

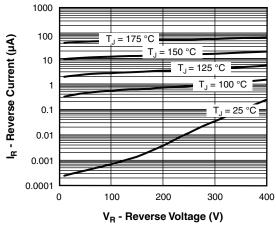


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



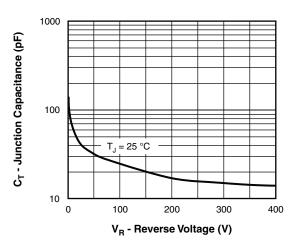


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

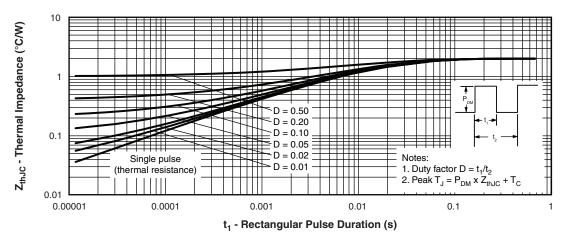


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

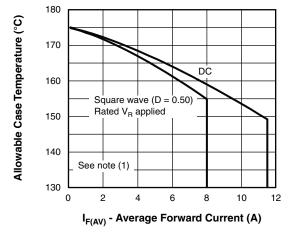


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

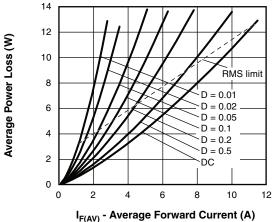


Fig. 6 - Forward Power Loss Characteristics

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; Pd = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); Pd_{REV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = rated V_R

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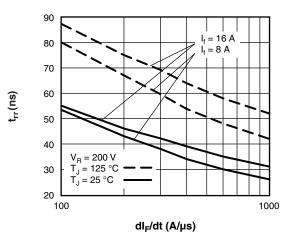


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

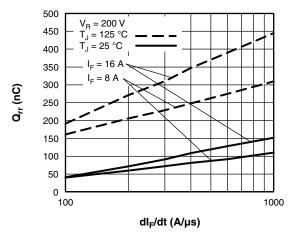
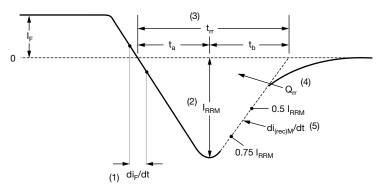


Fig. 8 - Typical Stored Charge vs. dl_F/dt



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm l_F$ to point where a line passing through 0.75 $\rm l_{RRM}$ and 0.50 $\rm l_{RRM}$ extrapolated to zero current.
- (4) Q_{rr} area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

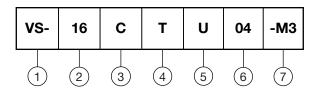
Fig. 9 - Reverse Recovery Waveform and Definitions



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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (16 = 16 A)

3 - Circuit configuration:

C = common cathode

4 - Package:

T = 3L TO-220AB

5 - Ultrafast recovery

6 - Voltage rating (04 = 400 V)

7 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N BASE QUANTITY PACKAGING DESCRIPTION								
VS-16CTU04-M3	50	Antistatic plastic tubes						

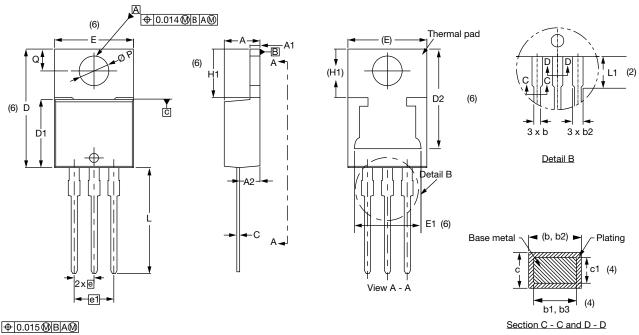
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?96154						
Part marking information	www.vishay.com/doc?95028						
SPICE model	www.vishay.com/doc?96565						

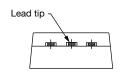


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TO-220AB 3L

DIMENSIONS in millimeters and inches





Conforms to JEDEC® outline TO-220AB

SYMBOL	MILLIM	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183			D2	11.68	13.30	0.460	0.524	6, 7
A1	1.14	1.40	0.045	0.055			Е	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2
c1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355								

Notes

- ⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



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